

# MSP2301N3

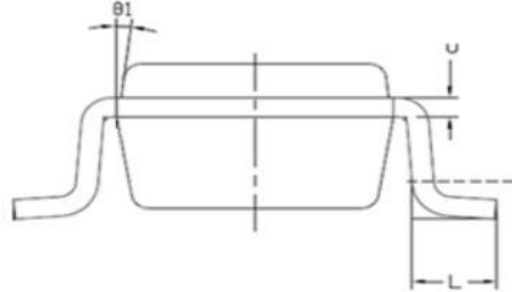
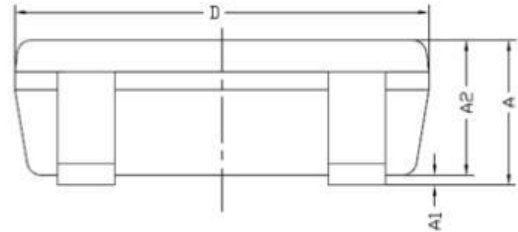
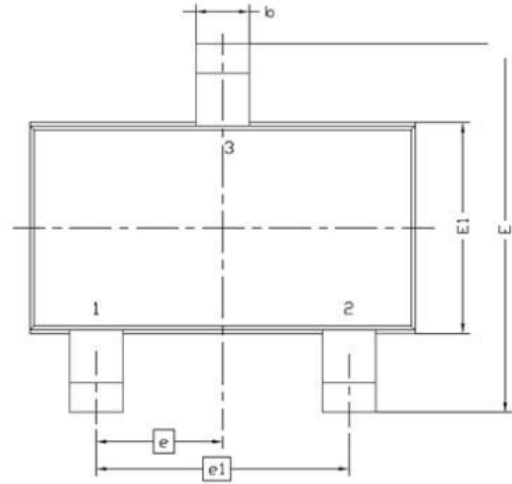
## 20V P-CHANNEL Enhancement Mode MOSFET

### Features

- $V_{DS} = -20V$   $R_{DS(ON)} = 130m\Omega @ V_{GS} = -4.5V$ ,  
 $I_{DS} = -2.8A$   $R_{DS(ON)} = 190m\Omega @ V_{GS} = -2.5V$ ,  
 $I_{DS} = -2A$
- Advanced trench process technology
- High density cell design for ultra low on resistance
- Excellent thermal and electrical capabilities
- Compact and low profile SOT-23 package
- RoHS compliant package

### Packing & Order Information

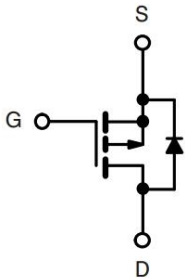
3,000/Reel



**RoHS**  
COMPLIANT



### Graphic symbol



Symbol	MILLIMETERS	
	MIN	MAX
A	0.8	1.2
A1	0	0.1
A2	0.7	1.1
b	0.3	0.5
c	0.1	0.2
D	2.7	3.1
E	2.6	3
E1	1.4	1.8
e	0.95 BSC	
e1	1.9 BSC	
L	0.3	0.6
θ1	7° NOM	

## MSP2301N3

### 20V P-CHANNEL Enhancement Mode MOSFET

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

##### Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage	-20	V
$V_{GS}$	Gate-Source Voltage	$\pm 8$	V
$I_D$	Drain Current -Continuous	-2.3	A
$I_{DM}$	Pulsed Drain Current	-10	A
$P_D$	Total Power Dissipation ( $T_A=25^{\circ}\text{C}$ )	1.25	W
	Total Power Dissipation ( $T_A=70^{\circ}\text{C}$ )	0.8	W
$T_J$	Operating Junction Temperature	-55 to +150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature	-55 to +150	$^{\circ}\text{C}$

##### Thermal Performance

Symbol	Parameter	Max.	Units
$R_{thja}$	Thermal Resistance, Junction-to- Ambient ( PCB mounted )	100	$^{\circ}\text{C}/\text{W}$
$T_L$	Lead Temperature, for 5 second soldering ( 1/8" from case )	260	$^{\circ}\text{C}$

Note: Surface mounted on FR-4 board,  $t \leq 5$  sec

##### Static

Symbol	Test Conditions	Min	Typ.	Max.	Units
$BV_{DSS}$	$V_{GS} = 0$ , $I_D = 250\mu\text{A}$	-20	--	--	V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$	-0.45	--	--	V
$I_{DSS}$	$V_{DS} = -16\text{ V}$ , $V_{GS} = 0\text{ V}$	--	--	-1	$\mu\text{A}$
$I_{GSS}$	$V_{GS} = \pm 8\text{ V}$ , $V_{DS} = 0\text{ V}$	--	--	$\pm 100$	nA
$*I_{D(ON)}$	$V_{DS} \geq -10\text{ V}$ , $V_{GS} = -5\text{ V}$	-6	--	--	A
$*R_{DS(ON)}$	$V_{GS} = -4.5\text{ V}$ , $I_D = -2.8\text{ A}$	--	95	130	$\text{m}\Omega$
	$V_{GS} = -2.5\text{ V}$ , $I_D = -2\text{ A}$	--	122	190	
$*G_{FS}$	$V_{DS} = 5\text{ V}$ , $I_D = -2.8\text{ A}$		6.5		S

## MSP2301N3

### 20V P-CHANNEL Enhancement Mode MOSFET

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$C_{ISS}$	Input Capacitance	$V_{DS} = -6\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1.0\text{ MHz}$	--	447	--	pF
$C_{OSS}$	Output Capacitance		--	127	--	pF
$C_{RSS}$	Reverse Transfer Capacitance		--	80	--	pF
$Q_g$	Total Gate Charge	$V_{DS} = -6\text{ V}$ , $I_D = -2.8\text{ A}$ , $V_{GS} = -4.5\text{ V}$	--	5.4	10	nC
$Q_{gs}$	Gate-Source Charge		--	0.8	--	nC
$Q_{gd}$	Gate-Drain Charge		--	1.1	--	nC
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 6\text{ V}$ , $I_D = -1\text{ A}$ , $R_L = 6\ \Omega$ , $V_{GEN} = -4.5\text{ V}$ $R_{GEN} = 6\ \Omega$	--	5	60	ns
$t_r$	Rise Time		--	19	110	ns
$t_{d(off)}$	Turn-Off Delay Time		--	95	80	ns
$t_f$	Fall Time		--	65	10	ns

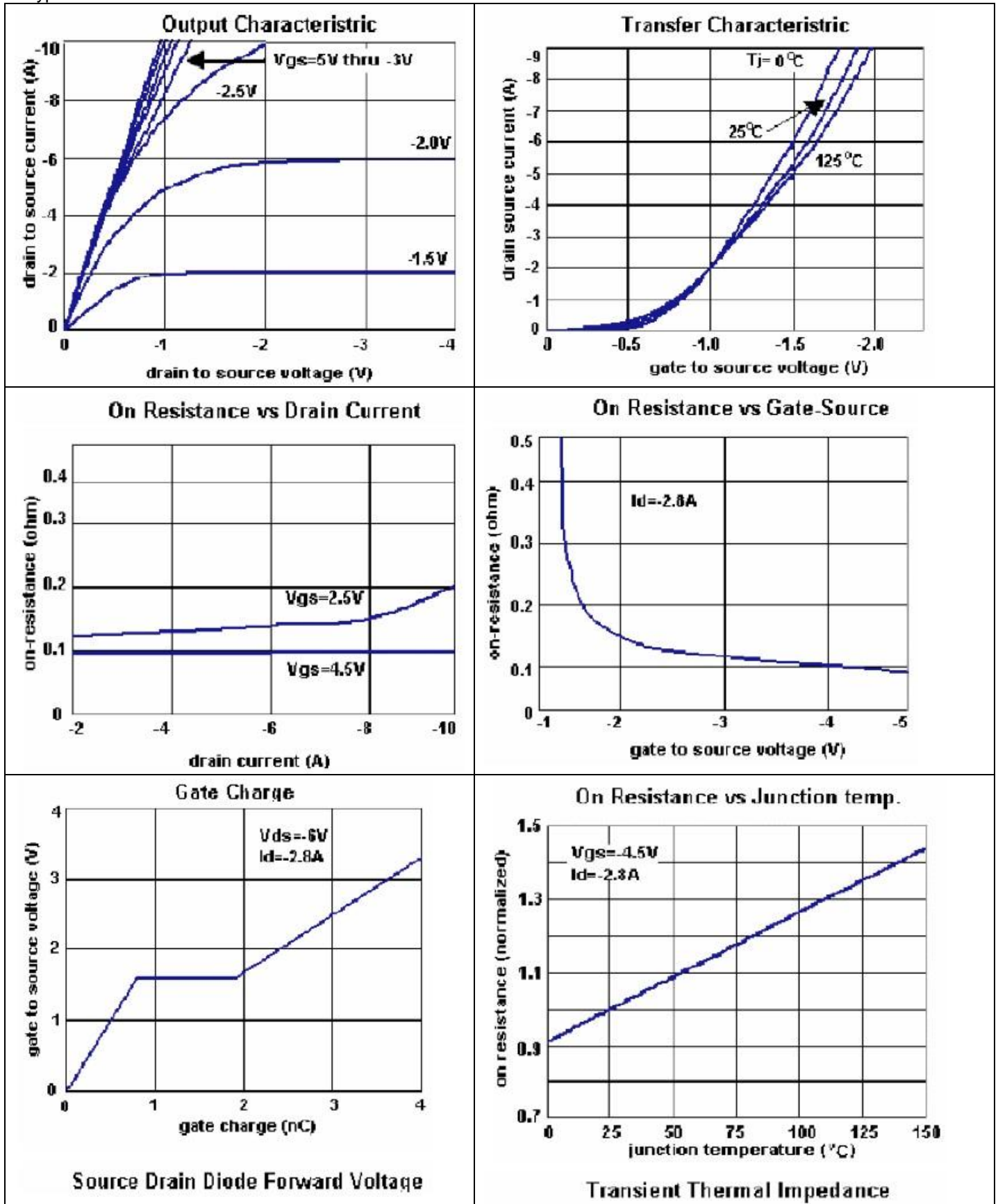
Static						
Symbol	Test Conditions	Min	Typ.	Max.	Units	
$I_{SD}$	-	--	--	1.6	A	
$V_{SD}$	$V_{GS} = 0\text{ V}$ , $I_{SD} = -1.6\text{ A}$	--	-0.8	-1.2	V	

Notes: Pulse test: PW ≤ 300us duty cycle ≤ 2%.

## MSP2301N3

20V P-CHANNEL Enhancement Mode MOSFET

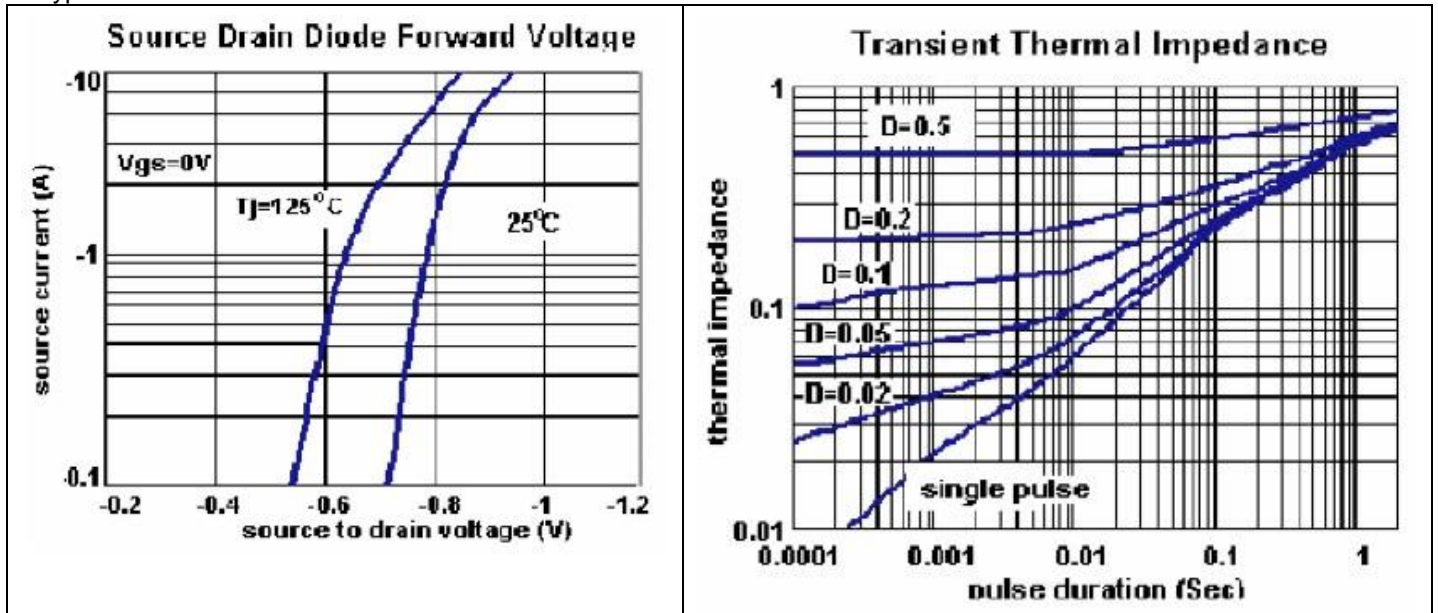
■ Typical Characteristics



## MSP2301N3

20V P-CHANNEL Enhancement Mode MOSFET

■ Typical Characteristics



## MSP2301N3

### 20V P-CHANNEL Enhancement Mode MOSFET

#### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Bruckewell Technology Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Bruckewell"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Bruckewell makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Bruckewell disclaims

- (i) Any and all liability arising out of the application or use of any product.
- (ii) Any and all liability, including without limitation special, consequential or incidental damages.
- (iii) Any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Bruckewell's knowledge of typical requirements that are often placed on Bruckewell products in generic applications.

Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time.

Product specifications do not expand or otherwise modify Bruckewell's terms and conditions of purchase, including but not limited to the warranty expressed therein.